

Fraunhofer Institute for Applied
Optics and Precision Engineering IOF



Dielectric reflection gratings with 275 mm width before slicing

Demanding applications. Customized solutions.



Description

Customized diffraction gratings for laser applications are designed, fabricated with lithographic technologies and characterized with respect to their optical parameters.

Parameters

- Reflection (R) or Transmission (T)
- Line density: up to 3500 l/mm
- Polarization: TE or TM
 Wavelength: 266 2100 nm
 Bandwidth: 20 100 nm
 Angle of incidence: Littrow (T)

 $< +/- 5^{\circ}$ off Littrow (R)

■ Efficiency: > 95 % over band-

width

> 99 % possible

■ Element size: < 275 x 120 mm² or

< 200 x 200 mm²

Substrate: fused silica

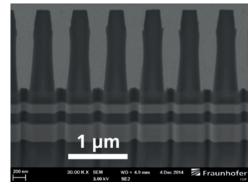
Service / technology

- Grating design
- Lithographic wafer-level processing:
 - Electron beam lithography
 - Reactive ion etching

- Characterization
 - Diffraction efficiency
 - Wave front error
- Dicing / machining of grating elements
- Backside anti-reflection coating (T)

Applications

- Laser pulse compression
- Phase gratings for FBG-Inscription
- DWM-components
- Beam shaping



SEM micrograph (post processed) of a grating profile cross section. Grating etched into a dielectric layer stack.

Top: Dielectric reflection

gratings during a full size measurement scan of diffraction efficiency.

Contact

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scan for more info